surface adjacent the upper face of the foil and an opposed upper surface and having an opening therethrough at the location of the electrode, whereby to form a well extending from the upper surface of the cover layer to the upper surface of the electrode and

e. separating the laminated coverlayer and foil from the mandrel.

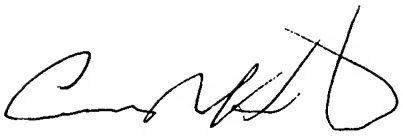
41. A method as in claim 40 and including the further step of underlaying the lower face of the foil with a non-conductive underlayer having a lower surface remote from the foil and an opening therethrough at a location adjacent the lower face of the foil, whereby to provide access to the lower face of the foil at said location to permit readily connectable and disconnectable pressure electrical interconnection with another element at the lower surface of the substrate.

42 A method as in claim 39 and wherein the conductive metal is comprised of copper and the electrode is comprised of a metal, metal chloride and/or metal oxide selected from silver, gold, palladium, nickel, platinum, iridium and their chlorides and oxides.

REMARKS

Claims 2 through 42 have been added to the application in order to claim more comprehensively the various features of this invention. Support for the language and relationships expressed in the claims is believed to be readily apparent in the summary of the invention and the detailed disclosure thereof in the specification as filed.

Respectfully submitted,



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